

NCEP40T17G

NCE N-Channel Super Trench Power MOSFET

Description

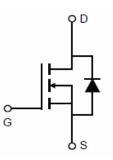
The NCEP40T17G uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =40V, I_D =170A $R_{DS(ON)}$ =1.25m Ω (typical) @ V_{GS} =10V $R_{DS(ON)}$ =1.55m Ω (typical) @ V_{GS} =4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 150 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

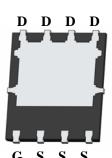
Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic Diagram





Top View

Bottom View

100% UIS TESTED!

100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP40T17G	NCEP40T17G	DFN5X6-8L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous (Silicon Limited)	I _D	170	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	120	А
Pulsed Drain Current (Package Limited)	I _{DM}	400	А
Maximum Power Dissipation	P _D	95	W
Derating factor		0.76	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1200	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	$^{\circ}$ C



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NCEP40T17G

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R ₀ JC	1.31	°C/W
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	40		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.5	2.2	V
Drain Course On Ctate Desistance		V _{GS} =10V, I _D =85A	-	1.25	1.5	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =85A	-	1.55	1.95	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =85A	-	80	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	\/ -20\/\/ -0\/	-	7400	8800	PF
Output Capacitance	Coss	V_{DS} =20V, V_{GS} =0V, F=1.0MHz	-	1930	2300	PF
Reverse Transfer Capacitance	C _{rss}	r=1.0WIn2	-	110	130	PF
Switching Characteristics (Note 4)	·					
Turn-on Delay Time	t _{d(on)}		-	14.1	-	nS
Turn-on Rise Time	t _r	V_{DD} =20V, I_D =85A	-	7.9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =1.6 Ω	-	56.5	-	nS
Turn-Off Fall Time	t _f		-	9.6	-	nS
Total Gate Charge	Qg	V -20VI -05A	-	125	140	nC
Gate-Source Charge	Q_{gs}	V_{DS} =20V, I_{D} =85A, V_{GS} =10V	-	18		nC
Gate-Drain Charge	Q_{gd}	V _{GS} -10V	-	13		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =85A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	170	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = I _S	-		35	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-		124	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V_DD=20V,V_G=10V,L=0.5mH,Rg=25 Ω

Pb Free Product



Typical Electrical and Thermal Characteristics

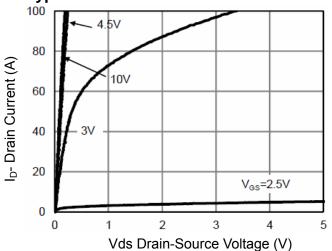


Figure 1 Output Characteristics

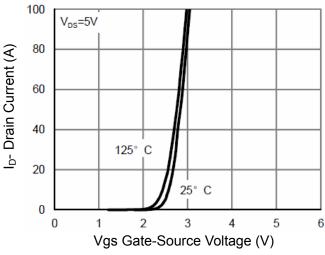


Figure 2 Transfer Characteristics

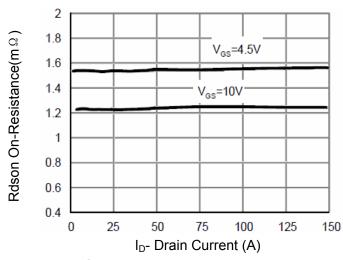


Figure 3 Rdson- Drain Current

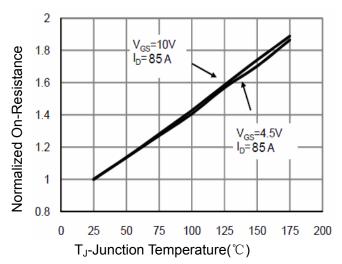


Figure 4 Rdson-Junction Temperature

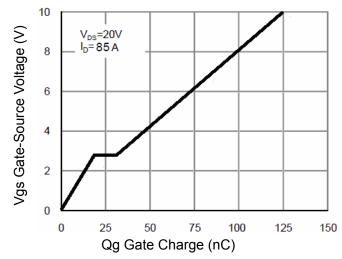


Figure 5 Gate Charge

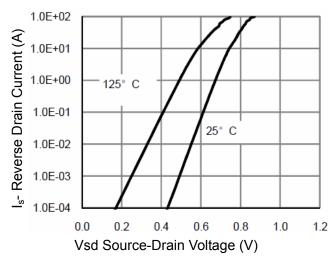


Figure 6 Source- Drain Diode Forward



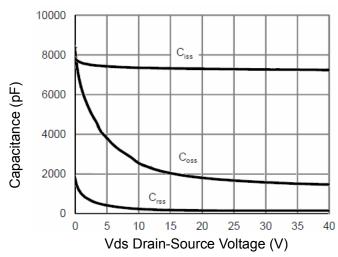


Figure 7 Capacitance vs Vds

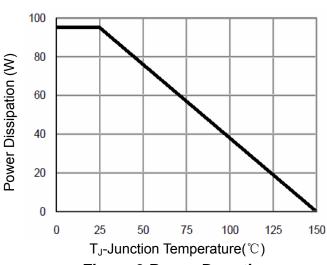


Figure 9 Power De-rating

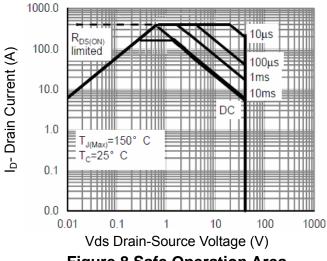


Figure 8 Safe Operation Area

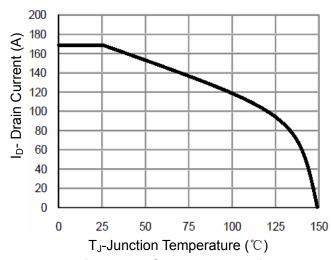


Figure 10 Current De-rating

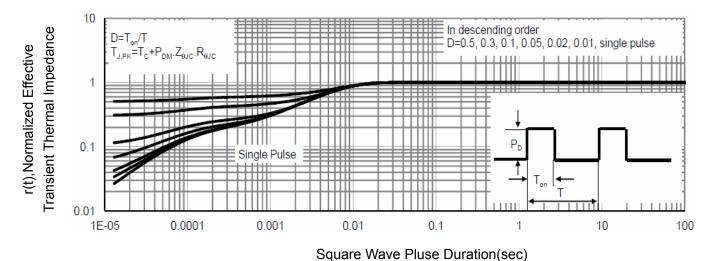
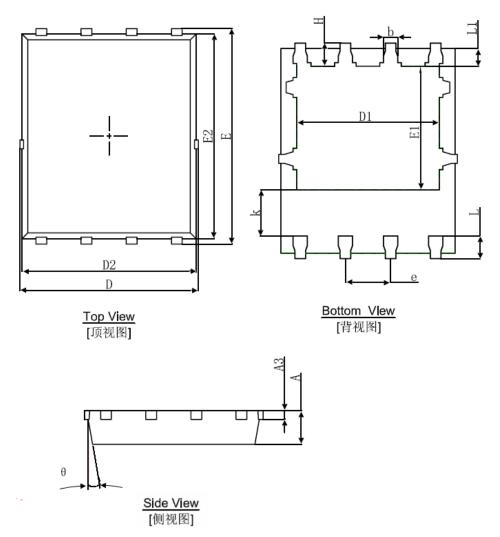


Figure 11 Normalized Maximum Transient Thermal Impedance



DFN5X6-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
A3	0.254REF.		0.010	REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270TYP.		0.050	TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	8°	12°	8°	12°	



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